



BAW156

DUAL SURFACE MOUNT LOW LEAKAGE DIODE

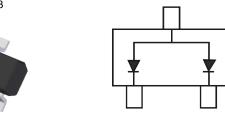
Features

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ BAW156Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 63
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)



Top View Internal Schematic

SOT23



Top View

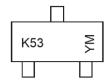
Ordering Information (Notes 4 & 5)

Part Number	Package	Pa	Packing		
	Fackage	Qty.	Carrier		
BAW156-7-F	SOT23	3,000	Tape & Reel		
BAW156Q-7-F	SOT23	3,000	Tape & Reel		
BAW156Q-13-F	SOT23	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/
- 5. Products manufactured with date code V9 (week 33, 2008) and newer are built with green molding compound. Products manufactured prior to date code V9 are built with non-green molding compound and may contain halogens or Sb₂O₃ fire retardants.

Marking Information



K53 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022)

M = Month (ex: 9 = September)

Date Code Key

Year	1998		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	J		J	K	L	М	N	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		_	2	4		6	7	0	0	^	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage		VR(RMS)	60	V
Forward Continuous Current (Note 6)	Single Diode Double Diode	I _{FM}	160 140	mA
Repetitive Peak Forward Current (Note 6)		IFRM	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	IFSM	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	Reja	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

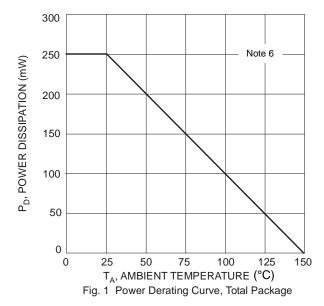
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V(BR)R	85	_	_	V	I _R = 100μA
		_	_	0.90	V	IF = 1.0mA
Forward Voltage	VF	_	_	1.0		$I_F = 10mA$
Forward Voltage	VF			1.1		IF = 50mA
		_	_	1.25		I _F = 150mA
Leakage Current (Note 7)	lo.	_	_	5.0	nA	V _R = 75V
	IR	_	_	80	nA	$V_R = 75V$, $T_J = +150$ °C
Total Capacitance	Ст	_	3	_	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	+			3.0		$I_F = I_R = 10mA$
	t _{rr}			3.0	μs	$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$

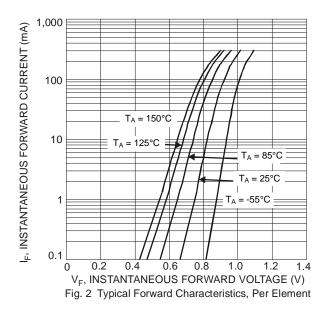
Notes:

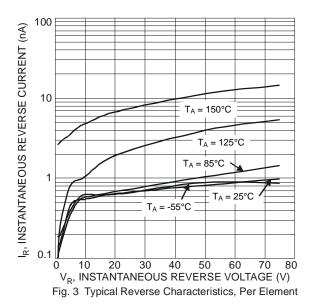
^{6.} Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

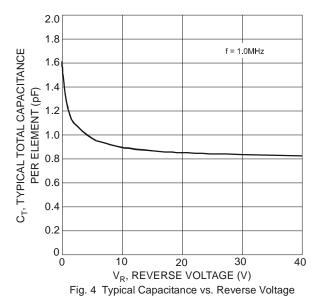
^{7.} Short duration pulse test used to minimize self-heating effect.









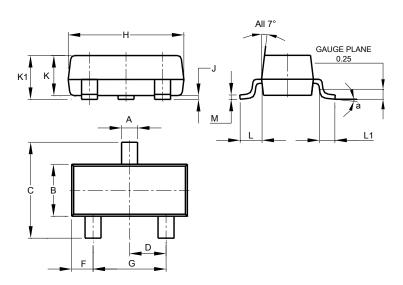




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

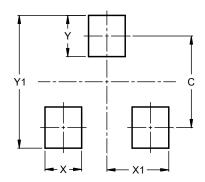


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
C	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
M	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
V1	2.0



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